



AF
2802

MAS-FIN-128

BOX AF

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450:

By: 

Date: DEC 15, 2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic. No. : 10/056,356 Confirmation No. 8042
Applicant : Harry Hedler et al.
Filed : January 24, 2002
TC/A.U. : 2831
Examiner : Hung V. Ngo
Title : Electronic Component with a Semiconductor
Chip and Method of Producing the Electronic
Component
Docket No. : MAS-FIN-128
Customer No. : 24131

BOX AF

Hon. Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

TECHNOLOGY CENTER 2800

DEC 30 2003

RECEIVED

RESPONSE under 37 C.F.R. § 1.116

S i r :

In response to the final Office action dated September 15, 2003, please consider the following remarks or arguments:

Remarks/Arguments begin on page 2 of this paper.